Interfacing an I2S Device to an MSP430 Device

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Keywords
- TLV320AIC26
- Codec
- MSP430
- I2S Bus

1 Introduction
The MSP430 series of microprocessors are fast powerful devices ideally suited for use with the various wireless transceivers offered by Texas Instruments. In streaming audio applications, however, it is desirable that the microprocessor support an audio bus to allow for interconnection to an audio CODEC. This application note describes how to create an I2S-like bus (left-justified mode) from an SPI bus using a 4-bit counter, a ‘D’ type flip-flop, and a dual inverter gate.

2 Abbreviations
BCLK – Bit Clock
Codec – Compressor-decompressor
LRCLK – Left/Right Clock
MCLK – Master Clock
DIN – Data In
MHz – Megahertz
DMA – Direct Memory Access
MSB – Most Significant Bit
DO – Digital Output
SPI – Serial Peripheral Interface Bus
DOUT – Data Out
µs – Microseconds
I2S – Inter-IC Sound Bus

3 SPI vs I2S
The fundamental difference between the I2S bus protocol and the SPI bus protocol is that I2S and its derivatives require a 'LR Clock' (Left/Right Clock) to indicate whether the 16 bits of data pertain to the left or to the right channel. An additional difference is that the SPI bus works in 8-bit bytes, whereas the I2S bus works in 16-bit words.

The I2S bus standard states that "In I2S mode, the MSB of the left channel is valid on the second rising edge of BCLK after the falling edge of LRCLK. Similarly, the MSB of the right channel is valid on the second rising edge of BCLK after the rising edge of LRCLK" (see Figure 1).

Figure 1. I2S Bus Timing
4 Left-Justified Mode

The I2S protocol is difficult to implement, due to the one BCLK delay between LRCLK and Data In ('DIN') and Data Out ('DOUT'). A much easier to implement, but similar protocol is 'left-justified mode' (see Figure 2).

![Figure 2. Left-Justified Mode Timing](image)

The left-justified mode standard states that "In left-justified mode, the MSB of the right channel is valid on the rising edge of BCLK following the falling edge of LRCLK. Similarly, the MSB of the left channel is valid on the rising edge of BCLK following the rising edge of LRCLK". For more details on I2S mode and its derivatives, see the Overview section of the TLV320AIC26 data sheet, Low Power Stereo Audio Codec with Headphone/Speaker Amplifier and 12 Bit Battery/Temperature/Auxiliary ADC (SLAS412).

5 Implementation

Figure 3 shows one possible implementation of a SPI to left-justified mode converter. Because a 5-bit counter in a single package is not readily available, a 4-bit counter is used (CD74AC161) along with SN74LVC1G175 D-type flip flop. Both the CD74AC161 and the SN74LVC1G175 are positive-edge triggered. The RCO (carry out) output of the counter goes high when a count of 15 is reached, and returns low when the counter resets to 0. An inverter (SN74LVC2G04) is placed between RCO and the clock of a D-type flip flop connected toggle mode, so that LRCLK toggles shortly after the counter resets (i.e., after 16 SCLK clocks) (see Figure 4).

The Px.x line is controlled by a DO bit of the MSP430. It should be held low (logic true) until the SPI control registers of the MSP430 are properly initialized.
Figure 3. Possible Hardware Implementation
Follows is sample 'C' code to initialize the UCB1 registers of a MSP430F5418 microprocessor for use with the hardware logic described previously.

```c
// The I2S bus to/from the Codec is created using an SPI bus (UCB1)
UCB1CTL1 = UCSWRST; // Hold USCI in Reset state

    // UCB1 Settings:
    // Master
    // 3 Pin SPI
    // 8 data bits
    // Clock Source: SMCLK (8.192 MHz)
    // Bit Rate Divider (BR0, BR1): 32 (Bit Rate = 256 kbps)
    // No Modulation
    // MSB First
    // Clock Phase - UCCKPL = 0, UCCKPH = 1
    // MSB first

UCB1CTL0 = UCCKPH | UCMSB | UCMST | UCMODE_0 | UCSYNC;
UCB1CTL1 |= UCSSEL_2;
UCB1BR0 = 32;
UCB1BR1 = 0;
UCB1CTL1 & = ~UCSWRST; // Enable USCI
```

It is imperative in any I2S bus application that the data stream continuously; that is, that data be sent to the TX buffer as it empties, and that RX buffer be read and stored before the next byte becomes available. One way to assure this is through the use of the MSP430 DMA channels.

Sample code for setting up two DMA channels to handle the transfer of data to and from the codec is shown below. In this scheme, DMA channel 0 is set up to generate an interrupt every 'ADC Samples' (number of ADC samples). For the TLV320AIC26 codec, two 16-bit ADC samples are sent to the MSP430 every 1 / sample_rate seconds (e.g., 125 μs for a sample rate of 8 kHz). Four memory bytes are allocated for each 'ADC_Sample'. The same is true for the Data Out stream; 4 bytes are allocated for every 'ADC_Sample'. In this case, ADC_SAMPLES has been set to 58; therefore, DMA channel 0 generates an interrupt every $58 \times 125 = 7250 \mu s$. 

![Converter Timing Diagram](image-url)
```c
#define ADC_SAMPLES 58 // ADC samples per packet

// allocate memory for the codec (audio) buffers
char codec_in_bufferA[4*ADC_SAMPLES]; // Audio from Codec (4 bytes per sample)
char codec_in_bufferB[4*ADC_SAMPLES]; // Audio from Codec (4 bytes per sample)
char codec_out_bufferA[4*ADC_SAMPLES]; // Audio to Codec (4 bytes per sample)
char codec_out_bufferB[4*ADC_SAMPLES]; // Audio to Codec (4 bytes per sample)

char act_codec_in_bufr = 0; // active codec_in buffer (0 | 1)
char act_codec_out_bufr = 0; // active codec_out buffer (0 | 1)

// Set up the DMA Controller. Channel 0 is used for I2S bus DO transfers (audio data
to codec). Channel 1 is used for I2S DI bus transfers (audio data from codec)

DMACTL0 = 0x1617; // DMA0TSEL = 23 (UCB1TXIFG)    // DMA1TSEL = 22 (UCB1RXIFG)

// DMA Channel 0 Control (I2S DO using UCB1)
// DMADT = Repeated single transfer
// DMADSTINCR = Destination address is unchanged
// DMASRCINCR = Source address is incremented
// Transfer byte to byte
// DMA interrupts enabled
DMA0CTL = DMADT_4 | DMADSTINCR_0 | DMASRCINCR_3 | DMASBDB | DMAIE;

// Source block address
__data16_write_addr((unsigned short) &DMA0SA, (unsigned long) &codec_out_bufferA);
// Destination Address
__data16_write_addr((unsigned short) &DMA0DA, (unsigned long) &UCB1TXBUF);
DMA0SZ = sizeof(codec_out_bufferA);

// DMA Channel 1 Control (I2S DI using UCB1)
// DMADT = Repeated single transfer
// DMADSTINCR = Destination address is incremented
// DMASRCINCR = Source address is unchanged
// Transfer byte to byte
// DMA interrupts disabled
DMA1CTL = DMADT_4 | DMADSTINCR_3 | DMASRCINCR_0 | DMASBDB;

// Source block address
__data16_write_addr((unsigned short) &DMA1SA, (unsigned long) &UCB1RXBUF);
// Destination block address
__data16_write_addr((unsigned short) &DMA1DA, (unsigned long) &codec_in_bufferA);
DMA1SZ = sizeof(codec_in_bufferA);
```
The interrupt handler for DMA channel 0 is set up to switch the buffers used by both DMA channels to the 'other' buffer:

```c
#pragma vector=DMA_VECTOR
__interrupt void DMA_ISR(void)
{
    DMA0CTL &= ~DMAIFG;

    if (act_codec_in_bufr == 0) {
        __data16_write_addr((unsigned short) &DMA1DA, (unsigned long) &codec_in_bufferA);
    } else {
        __data16_write_addr((unsigned short) &DMA1DA, (unsigned long) &codec_in_bufferB);
    }
    act_codec_in_bufr ^= 0x01; // switch buffers

    if (act_codec_out_bufr == 0) {
        __data16_write_addr((unsigned short) &DMA0SA, (unsigned long) &codec_out_bufferA);
    } else {
        __data16_write_addr((unsigned short) &DMA0SA, (unsigned long) &codec_out_bufferB);
    }
    act_codec_out_bufr ^= 0x01; // switch buffers

    sendpacket = 1;
}
```

Variable 'sendpacket' is a flag, used to indicate that 'ADC_SAMPLES' samples have been received, and that the codec buffers have been switched.

6 Conclusion
This application note describes a way to interface a standard CODEC (for example, TLV320AIC26), to an MSP430 microcontroller (for example, MSP430F5418) using a SPI port. It uses the left-justified mode variant of the standard I2S bus protocol and can be implemented simply and inexpensively using a 4-bit counter, a 'D' type flip-flop, and a dual inverter gate.

7 References
1. TLV320AIC26 specification sheet, Low Power Stereo Audio Codec with Headphone/Speaker Amplifier and 12 Bit Battery/Temperature/Auxiliary ADC (SLAS412)

8 Document History

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<td>SWRA295</td>
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